

TPG3AU1S09 – Next-generation Pulsed Laser Diode in TO-56 package Low V_F Edge Emitting Laser Diode at 905 nm



Excelitas' TPG3 lasers produce very high peak optical pulses with a typical efficiency of 3 W/A and a centered wavelength at 905 nm. The lasers are available in metal can TO-56 packages.

Key Features

125 W at 40 A output power with 3 W/A slope:

- Delivers perfect performance for precise long-range LiDAR systems
- Offers excellent balance of performance and efficiency

11 V forward voltage:

- Enables energy-efficient operation, reducing power consumption
- Lower thermal load simplifies cooling and increases system lifespan

215 μm x 10 μm emission size:

- Supports precise beam shaping for high-resolution ranging
- Ideal for tight optical systems and precise spatial resolution

High Reliability:

- Ensures consistent performance over time in harsh or mission-critical environments
- Reduces downtime and maintenance costs

Homogeneous Near Field Distribution:

- Produces a uniform beam profile, improving measurement accuracies and signal stability
- Enhanced performance in short-range or high-resolution applications

Applications

- LiDAR / ToF measurements
- Industrial Automation & Robotics
- 3D Sensing for logistics and warehouses
- Automotive LiDAR
- Laser therapy
- Mapping, Drones, Geodata
- Consumer ToF systems

TPG3AU1S09 – Next-generation Pulsed Laser Diode in TO-56 package

Low V_F Edge Emitting Laser Diode at 905 nm

All specifications are valid for $T_A = 23\text{ }^{\circ}\text{C}$, $t_p = 100\text{ ns}$, $f_p = 1\text{ kHz}$ and $i_F = 40\text{ A}$, unless otherwise specified.

Table 1: Key parameters

Parameter	Symbol	Minimum	Typical	Maximum	Unit
Peak Optical Power	P		125		W
Wavelength	λ_C	895	905	915	nm
Power Slope above threshold current	$\Delta P/\Delta I$		3.3		W/A
Operating Temperature ¹	T_{op}	-40		85	$^{\circ}\text{C}$

Note 1: Extended temperature range specification available. Please contact Excelitas Technologies for more information.

Table 2: Absolute Maximum Ratings

Parameter	Symbol	Value	Units
Reverse Breakdown Voltage	V_{BD}	40	V
Peak Forward Current	I_F	40	A
Pulse Duration	t_W	150	ns
Duty Factor	du	0.1	%
Storage Temperature	T_S	-40 ... 105	$^{\circ}\text{C}$
Soldering for 5 Seconds (leads only)		260	$^{\circ}\text{C}$

Note 1: Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device.

Note 2: Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note 3: Laser diodes are intended to be operated in forward current conditions. Reverse biasing shall be avoided.

Table 3: Chip and Nearfield Specifications

Parameter	Symbol	Minimum	Typical	Maximum	Units
Number of stripes	S		3		-
Emitting width ^{1,2}	w		215		μm
Emitting height ^{1,2}	h		10		μm

Note 1: The emitting area is defined as FWHM(w) x FWHM(h) of the nearfield size at 40 A.

Note 2: Parameter changes slightly with drive current. Please contact Excelitas Technologies for more information.

TPG3AU1S09 – Next-generation Pulsed Laser Diode in TO-56 package

Low V_F Edge Emitting Laser Diode at 905 nm

Table 4: Emission Specifications

Parameter	Symbol	Minimum	Typical	Maximum	Units
Spectral Width (FWHM)	$\Delta\lambda$		10		nm
Wavelength junction Temperature Coefficient	$\Delta\lambda/\Delta T_j$		0.25		nm/°C
Package Thermal Resistance ¹	R_{th}		65		°C/W
Divergence Parallel to Junction Plane	$\theta_{ }$		10		degrees
Divergence Perpendicular to Junction Plane	$\theta_{\perp}$		20		degrees

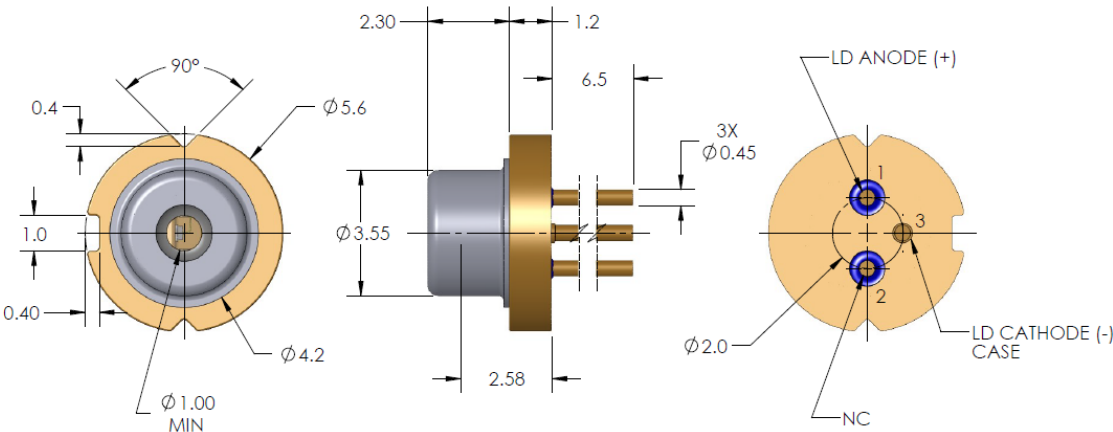
Note 1: Simulated from the Chip Junction to the cathode PCB connection lead

Table 5: Electrical Specifications

Parameter	Symbol	Minimum	Typical	Maximum	Units
Forward Voltage ¹	V_F		11		V
Threshold Current	i_{Th}		1.4		A
Series Resistance	R_s		0.13		Ω
Bandgap Voltage Drop	V_g		6.25		V
Package Inductance	L_p		5.0		nH

Note 1: As estimated by $V_F = R_S i_F + V_g$.

Figure 1: Laser Package Dimension



DIMENSIONS ARE IN MILLIMETERS
AND ARE FOR REFERENCE ONLY

Low V_F Edge Emitting Laser Diode at 905 nm

Figure 2: Typical P vs. i_F

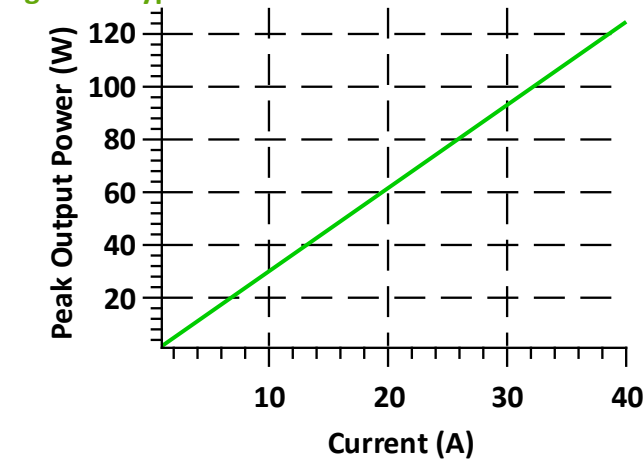


Figure 3: Typical V_F vs. i_F

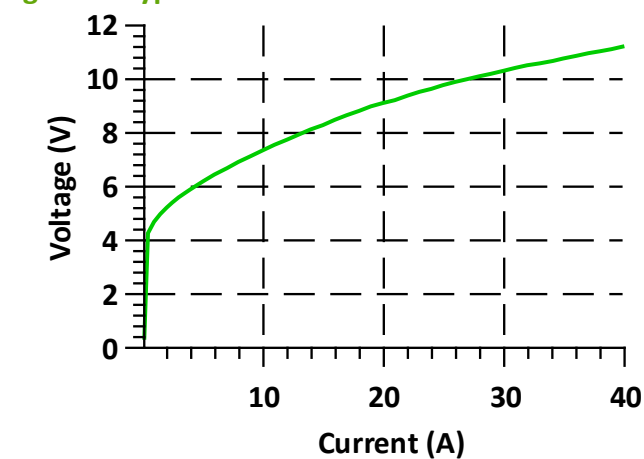


Figure 4: Typical λ vs. T_j

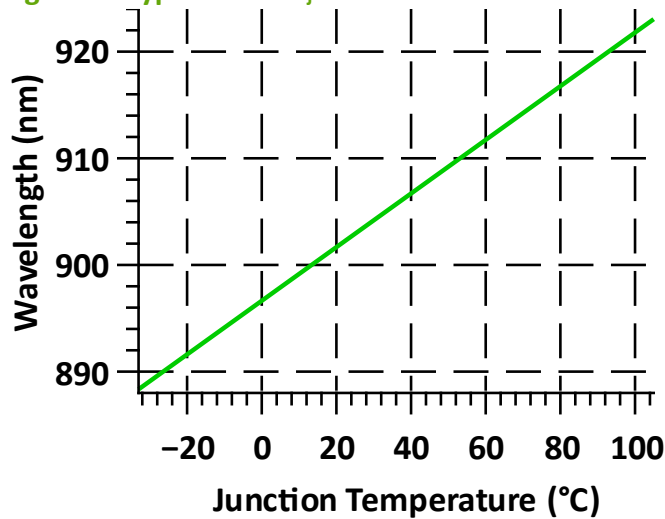
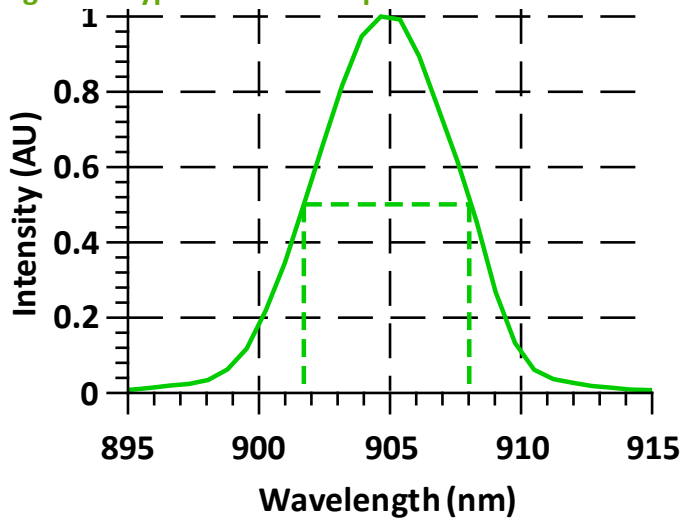


Figure 5: Typical Emission Spectrum



Low V_F Edge Emitting Laser Diode at 905 nm

Figure 6: Typical $\theta_{\perp}$

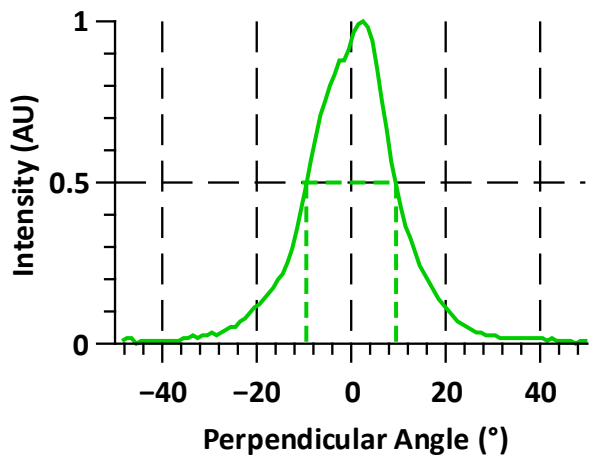


Figure 7: Typical $\theta_{\parallel}$

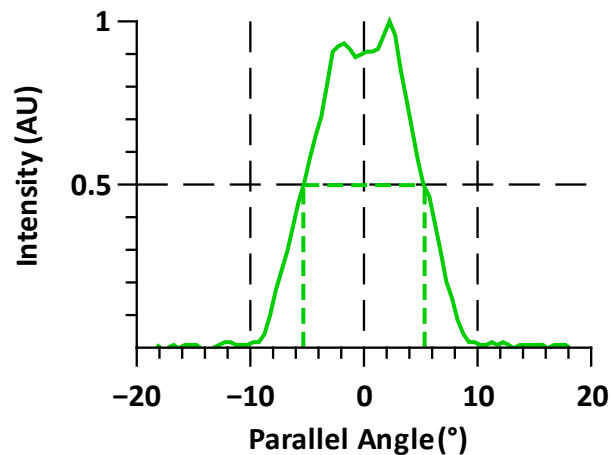


Figure 8: Typical P vs T_j

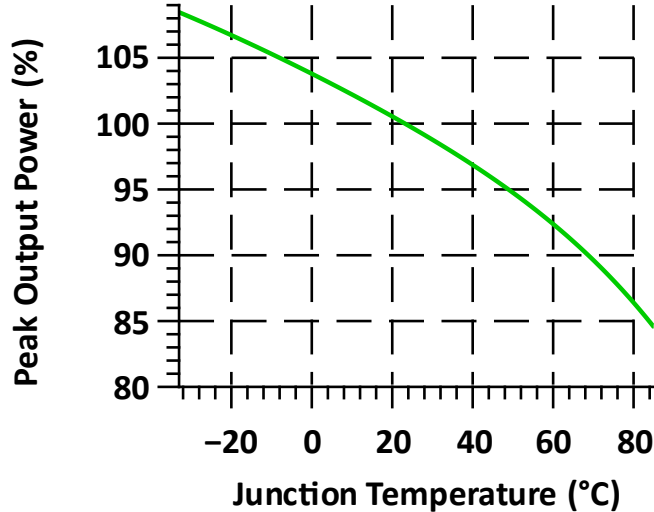
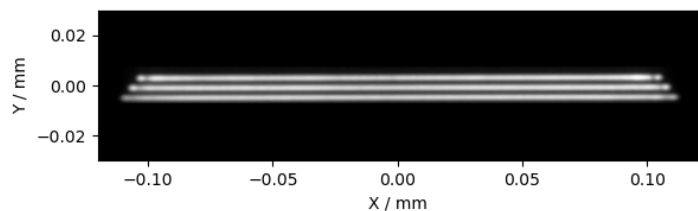


Figure 9: Typical Near Field Image



TPG3AU1S09 – Next-generation Pulsed Laser Diode in TO-56 package

Low V_f Edge Emitting Laser Diode at 905 nm

Information

Excelitas Technologies' TPG3AU1S09 next-generation pulsed semiconductor laser, emitting at 905 nm in the near IR, uses a multi-layer monolithic chip design. Its improved structure on GaAs substrate is offering 125 W pulsed peak power at a reduced forward voltage. The multi-layer chip design features an emitting area of $(215 \times 10) \mu\text{m}$ by emission of three laser lines, offering high output power in a small emitting area. The laser chips are fabricated by using metal organic chemical vapor deposition (MOCVD).

The hermetic TO-56 package complements Excelitas' TPG3 series epi-cavity lasers in SMD packages and are ideally suited for demanding applications in harsh environments.

The beam propagation possesses a 20° divergence in the direction perpendicular to the chip surface and 10° divergence parallel to the chip surface. The output power shows an excellent stability over the full MIL specification temperature range.

Our quantum well laser design offers rise and fall times of $< 1 \text{ ns}$. However, the drive circuit layout, packaging and mounting inductance play a dominant role and should be designed in accordance with the desired optical pulse width.

Where fiber coupling applications are concerned, the transverse spacing of the epi-cavity active area concentrates more optical power into a smaller geometry allowing for increased optical power coupling into optical fibers.

Please contact our experts at Excelitas Technologies when pulse widths in the range of 1 ns or fiber coupling applications are planned.

The peak wavelength at 905 nm is centered near the maximum responsivity of most silicon photodiodes. The TPG3AU1S09 laser matches especially well with devices from the Excelitas EPI-APD C30737 family.

Unconnected laser dies as shipped cannot emit light. Light emission requires installation into an electrical driver circuit.

TPG3AU1S09 – Next-generation Pulsed Laser Diode in TO-56 package

Low V_F Edge Emitting Laser Diode at 905 nm

Principle of operation

The light output of a laser diode is proportional to the current running through the laser by pulsing it in the forward bias direction. A simple way of allowing a large current to flow within nanoseconds through the laser is to discharge a large capacitor into the laser by closing a GaN-FET.

Excelitas recommends the use of a low-side driver to operate the laser. A detailed description of the circuitry to recharge the capacitors is omitted here since many options are available on the market. The voltage on the capacitors and discharge time will dictate the current flow in the laser.

Electrical circuits should be designed to protect the diodes from high current and reverse voltage transients. Optimum long-term reliability will be attained with the semiconductor at or below room temperature. Adequate heat sinking should be employed, particularly when operating at maximum duty cycle.

Package inductance

When narrow pulse widths are required, the system designer must take care that circuit inductance is kept to a minimum. Using a low inductance package will reduce the peak voltage required to obtain the desired drive current.

For example, to obtain approximate Gaussian pulse shapes of 40 ns and 1 ns, the below voltage should be considered in addition to the typical forward voltage:

- 40 ns:
 - $t_p = 40 \text{ ns}, t_r = 20 \text{ ns}$
 - $I_F = 40 \text{ A}, L_P = 5 \text{ nH}$
 - $V_P = \frac{5 \text{ nH} \times 40 \text{ A}}{20 \text{ ns}} = 10 \text{ V}$
- 1 ns:
 - $t_p = 1 \text{ ns}, t_r = 0.5 \text{ ns}$
 - $I_F = 40 \text{ A}, L_P = 5 \text{ nH}$
 - $V_P = \frac{5 \text{ nH} \times 40 \text{ A}}{0.5 \text{ ns}} = 400 \text{ V}$

Automotive Applications

For requests on automotive applications and more information, please contact our experts or visit our website.

TPG3AU1S09 – Next-generation Pulsed Laser Diode in TO-56 package

Low V_f Edge Emitting Laser Diode at 905 nm

Testing methods

Excelitas verifies the electro optical specifications on all parts at the maximum drive conditions. Visual inspection during fabrication is performed as per our quality standard.

Packaging and shipping

For production and sampling quantities, lasers are placed inside plastic trays.

Storage and handling

This laser is a static-sensitive device. Therefore, Excelitas highlights the following notes:

- Keep unused devices in ESD-safe material
- Protect devices from static discharge and static fields
- Precautions should be taken to avoid reverse polarity of power supply. Reversed polarity of power supply above the breakdown voltage listed under “Absolute Maximum Ratings” results in a destroyed unit.

TPG3AU1S09 – Next-generation Pulsed Laser Diode in TO-56 package

Low V_f Edge Emitting Laser Diode at 905 nm

For Your Safety: Laser Radiation

Under operation, these devices produce invisible electromagnetic radiation that may be harmful to the human eye. To ensure that these laser components meet the requirements of Class IIIb laser products, they must not be operated outside their maximum ratings. Power supplies used with these components must be such that the maximum peak forward current cannot be exceeded. It is the responsibility of the user incorporating a laser into a system to certify the Class of use and ensure that it meets the requirements of the ANSI or appropriate authority.

Further details may be obtained in the following publications:

21CFR 1040.10 – “Performance Standards for Light Emitting Products (Laser Products)”

ANSI Z136.1 – “American National Standard for Safe use of Lasers”

IEC 60825-1 – “Safety of Laser Products”

RoHS Compliance

This series of laser diodes are designed and built to be fully compliant with the European Union Directive on restrictions of the use of certain hazardous substances in electrical and electronic equipment.



Warranty

A standard 12-month warranty following shipment applies.

About Excelitas Technologies

Excelitas Technologies is a global technology leader focused on delivering innovative, customized solutions to meet the lighting, detection and other high-performance technology needs of OEM customers.

Excelitas has a long and rich history of serving our OEM customer base with optoelectronic sensors and modules for more than 45 years beginning with PerkinElmer, EG&G, and RCA. The constant throughout has been our innovation and commitment to delivering the highest quality solutions to our customers worldwide.

From aerospace and defense to analytical instrumentation, clinical diagnostics, medical, industrial, and safety and security applications, Excelitas Technologies is committed to enabling our customers' success in their specialty end-markets. Excelitas Technologies has approximately 7,000 employees in North America, Europe and Asia, serving customers across the world.

Excelitas Technologies

22001 Dumberry Road
Vaudreuil-Dorion, Quebec
Canada J7V 8P7
Telephone: (+1) 450.424.3300
Toll-free: (+1) 800.775.6786
Fax: (+1) 450.424.3345

Excelitas Technologies

GmbH & Co. KG
Wenzel-Jaksch-Str. 31
D-65199 Wiesbaden
Germany
Telephone: (+49) 611 492 430
Fax: (+49) 611 492 165

Excelitas Technologies Singapore, Pte. Ltd.

8 Tractor Road
Singapore 627969
Telephone: (+65) 6775 2022 (Main number)
Telephone: (+65) 6770 4366 (Customer Service)
Fax: (+65) 6778-1752



Contact us at: <https://www.excelitas.com/contact>

For a complete listing of our global offices, visit www.excelitas.com/locations

© 2025 Excelitas Technologies Corp. All rights reserved. The Excelitas logo and design are registered trademarks of Excelitas Technologies Corp. All other trademarks not owned by Excelitas Technologies or its subsidiaries that are depicted herein are the property of their respective owners. Excelitas reserves the right to change this document at any time without notice and disclaims liability for editorial, pictorial or typographical errors.